

DN6853

Switch type, Wide operating supply voltage range ($V_{CC} = 3.6 \text{ V to } 16 \text{ V}$)
Alternating magnetic field operation

Overview

DN6853 is a semiconductor integrated circuit utilizing the Hall effect. It has been so designed as to operate in the alternating magnetic field especially at low supply voltage. This Hall IC is suitable for application to various kinds of sensors, contactless switches, and the like.

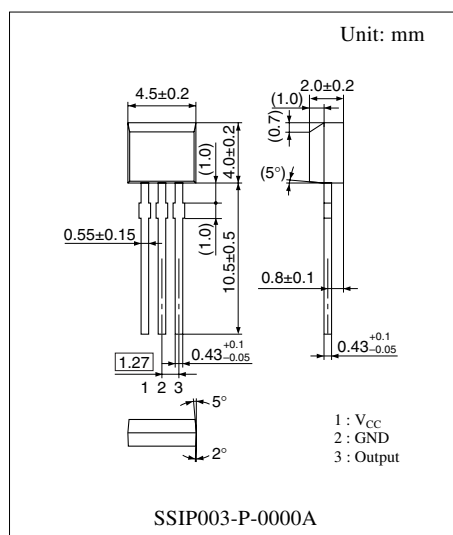
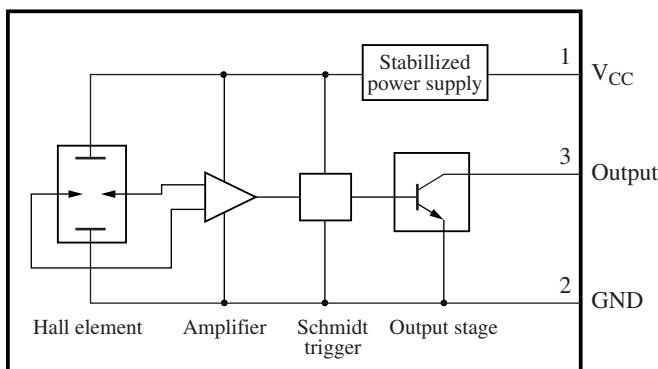
Features

- Wide supply voltage range of 3.6 V to 16 V
- Alternating magnetic field operation
- TTL and MOS IC are directly drivable by the output.
- The life is semipermanent because it employs contactless parts.
- SSIP003-P-0000A package
- Open collector output

Applications

- Speed sensor, position sensor, rotation sensor, keyboard switch, micro switch and the like

Block Diagram



Note) The package of this product will be changed to lead-free type (SSIP003-P-0000H). See the new package dimensions section later of this datasheet.

■ Absolute Maximum Ratings

Parameter	Symbol	Rating	Unit
Supply voltage	V_{CC}	18	V
Supply current	I_{CC}	8	mA
Circuit current	I_O	20	mA
Power dissipation	P_D	100	mW
Operating ambient temperature	T_{opr}	-40 to +85	°C
Storage temperature	T_{stg}	-55 to +125	°C

Note) This IC is not suitable for car electrical equipment.

■ Recommended Operating Range

Parameter	Symbol	Range	Unit
Supply voltage	V_{CC}	3.6 to 16	V

■ Electrical Characteristics at $T_a = 25^\circ\text{C}$

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Operating magnetic flux density	$B_{1(L-H)}$	$V_{CC} = 12\text{ V}$	-30	—	—	mT
	$B_{2(H-L)}$	$V_{CC} = 12\text{ V}$	—	—	30	mT
Low-level output voltage	V_{OL}	$V_{CC} = 16\text{ V}, I_O = 12\text{ mA}, B = 30\text{ mT}$	—	—	0.4	V
		$V_{CC} = 3.6\text{ V}, I_O = 12\text{ mA}, B = 30\text{ mT}$	—	—	0.4	V
Output current	I_{OH}	$V_{CC} = 16\text{ V}, V_O = 18\text{ V}, B = -30\text{ mT}$	—	—	10	V
		$V_{CC} = 3.6\text{ V}, V_O = 18\text{ V}, B = -30\text{ mT}$	—	—	10	V
Supply current	I_{CC}	$V_{CC} = 16\text{ V}$	—	—	6	mA
		$V_{CC} = 3.6\text{ V}$	—	—	5.5	mA

Note) 1. An 'A' rank type which operating magnetic flux density is $\pm 20\text{ mT}$ is also available.

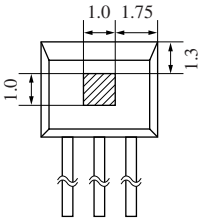
- The variation of operating magnetic flux density does not depend on supply voltage due to its built-in stabilized power source. (V_{CC} should be confined to the range of 3.6 V to 16 V.)
- A supply current increases by approximately 1 mA when its output level varies from high to low.

■ Technical Data

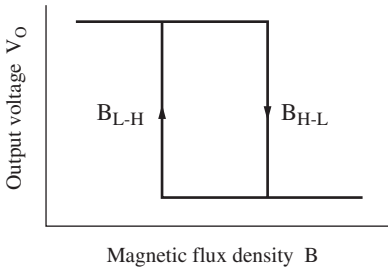
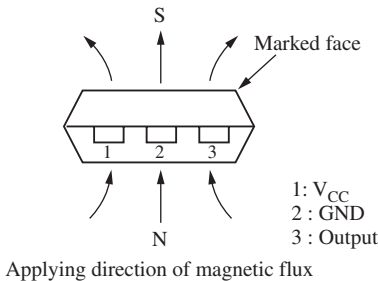
• Position of Hall element (unit: mm)

Distance from package surface to sensor part: 0.7 mm

A Hall element is placed on the shaded part in the figure.



• Magneto-electro conversion characteristics



■ Caution on Use of Hall ICs

The Hall ICs are often used to detect movement. In such cases, the position of the Hall IC may be changed by exposition to shock or vibration over a long period of time, and it causes the detection level change. To prevent this, fix the package with adhesives or fix it on a dedicated case.

1. A case using an adhesive

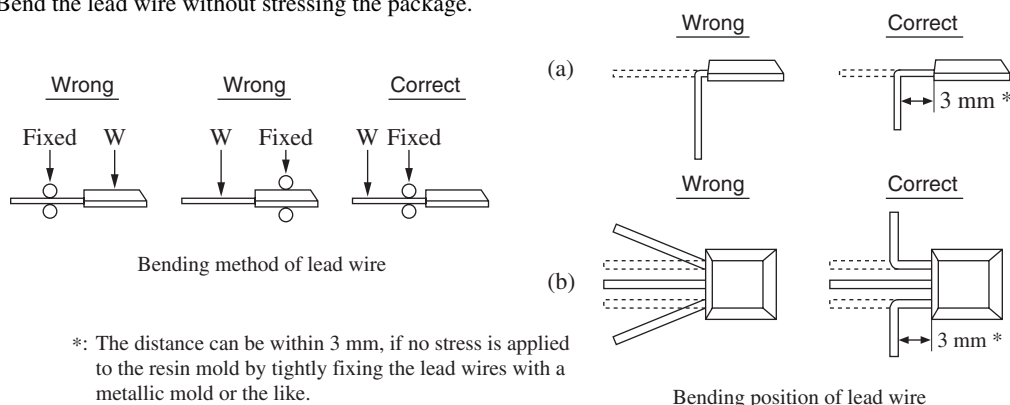
Some kinds of adhesive generate corrosive gas (such as chloric gas) during curing. This corrosive gas corrodes the aluminum on the surface of the Hall IC, and may cause a functional defect of disconnection.

If Hall IC is to be sealed after installation, attention should be given to the adhesive or resin used for peripherals and substrate cleaner, as well as to the adhesive used for Hall IC installation. Please confirm the above matter to those manufacturers before using.

We could not select the specified adhesive, for we find it difficult to guarantee the ingredient of each adhesive.

2. A case bending lead wire

Bend the lead wire without stressing the package.



3. Power supply line/Power transmission line

If a power supply line/power transmission line becomes longer, noise and/or oscillation may be found on the line. In this case, set the capacitor of 0.1 μF to 10 μF near the Hall IC to prevent it.

If a voltage of 18 V or more is thought to be applied to the power supply line (flyback voltage from coil or the ignition pulse, etc.), avoid it with external components (capacitor, resistor, Zener diode, diode, surge absorbing elements, etc.).

4. V_{CC} and GND

Do not reverse V_{CC} and GND. If the V_{CC} and GND pins are reversely connected, this IC will be destroyed. If the IC GND-pin voltage is set higher than other pin voltage, the IC configuration will become the same as a forward biased diode. Therefore, it will turn on at the diode forward voltage (approximately 0.7 V), and a large current will flow through the IC, ending up in its destruction. (This is common to monolithic IC.)

5. Cautions on power-on of Hall IC

When a Hall IC is turned on, the position of the magnet or looseness may change the output of a Hall IC, and a pulse may be generated. Therefore, care should be given whenever the output state of a Hall IC is critical when the supply power is on.

6. Fixing a Hall IC

When the Hall IC of an insertion type package installed by soldering the lead wire only is to be used under vibration, fix it firmly with a holder. Otherwise, vibration may cause metal fatigue in the lead wire of Hall IC, resulting in wire breakage.

7. On fixing a Hall IC to holder

When a Hall IC is mounted on the printed circuit board with a holder and the coefficient of expansion of the holder is large, the lead wire of the Hall IC will be stretched and it may give a stress to the Hall IC.

If the lead wire is stressed intensely due to the distortion of holder or board, the adhesives between the package and the lead wire may be weakened and cause a minute gap resulting in the deterioration of its resistance to moisture. Sensitivity may also be changed by this stress.

■ Caution on Use of Hall ICs (continued)

8. On using flux in soldering

Choose a flux which does not include ingredients from halogen group, such as chlorine, fluorine, etc. The ingredients of halogen group may enter where the lead frame and package resin joint, causing corrosion and the disconnection of the aluminum wiring on the surface of an IC chip.

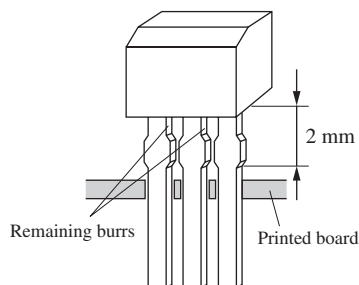
9. In case of the magnetic field of a magnet is too strong

Output may be inverted when applying a magnetic flux density of 100 mT or more. Accordingly, magnetic flux density should be used within the range of 100 mT.

10. On mounting, deburring and soldering of insertion type package

If the leads of a Hall IC in an insertion type package are inserted up to their root part through holes on the printed circuit board, abnormal stress is applied to the package and the reliability of the Hall IC is likely to deteriorate. So, when mounting each Hall IC of the insertion type, insert the leads in due degree at which the bottom face of the package is separated at least 2 mm from the top face of the PCB.

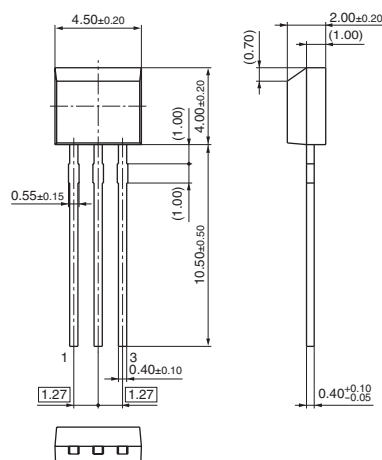
Also note that burrs of epoxy resin may be left sticking to the lead wires. (We are trying to remove such burrs as much as possible in the deburring process, but in some cases, they are not perfectly removable.)



When soldering the leads, remember to separate the soldering position by 2 mm or more from the resin part of the package.

■ New Package Dimensions (Unit: mm)

• SSIP003-P-0000H (Lead-free package)



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